

Attorney's Docket No.: 042390.P3955D

Patent

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71609
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Andideh, E. et al.

U.S. Serial No: 09/436,092

Filed: November 8, 1999

For: POLISH PAD WITH
NON-UNIFORM GROOVE DEPTH
TO IMPROVE WAFER POLISH RATE
UNIFORMITY

Examiner: McDonald, Shantese

Art Unit: 3723

Assistant Commissioner for Patents
Washington, D.C. 20231

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MAY 03 2002

GROUP 3700

AMENDMENT AND RESPONSE

Dear Sir:

This is in response to the Office Action mailed August 28, 2001. Applicant respectfully requests the Examiner to enter the following amendments and consider the following remarks.

FIRST CLASS CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to the Assistant Commissioner of Patents, Washington, D.C. 20231

on January 28, 2002

Date of Deposit

Teresa Edwards

Name of Person Mailing Correspondence

Teresa Edwards
Signature

January 28, 2002
Date